Axcelis is Uniquely Positioned with the Capability, DNA, and Unwavering Focus to solve customers' high value, high impact, ion implantation challenges.



Safe Harbor Statement

This presentation and discussion contain forward-looking statements, including our expectations for future revenues, expense reductions, profits, and other results that are forward-looking statements under the SEC's safe harbor provision. These forward-looking statements are based on management's current expectations, and are subject to the risks inherent in our business. These risks are described in detail in our Form 10-K annual report and other SEC filings. Our actual results may differ materially from our current expectations. We do not assume any obligation to update these forward-looking statements.



Axcelis at a Glance

- Global leader in technology development and manufacturing of ion implant systems and services for the semiconductor industry for over 40 years
 - Serving an estimated \$1B ion implant systems market
 - Based in Beverly, MA with headcount of approximately 1000 worldwide
 - Global infrastructure supporting customers in 31 countries
 - Growing installed base of over 3200 tools
 - Strong IP portfolio with >800 patents
- Supplier of record to leading semiconductor CAPEX spenders in all market segments including DRAM, Flash, Foundry and Logic







Recent Axcelis Technologies Achievements





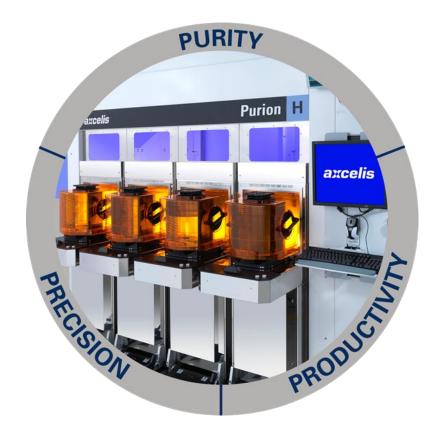


Top 100 women-led businesses

Axcelis Named to Forbes' List of America's Best Small-Cap Companies Ranking #19 Out of 100 Companies



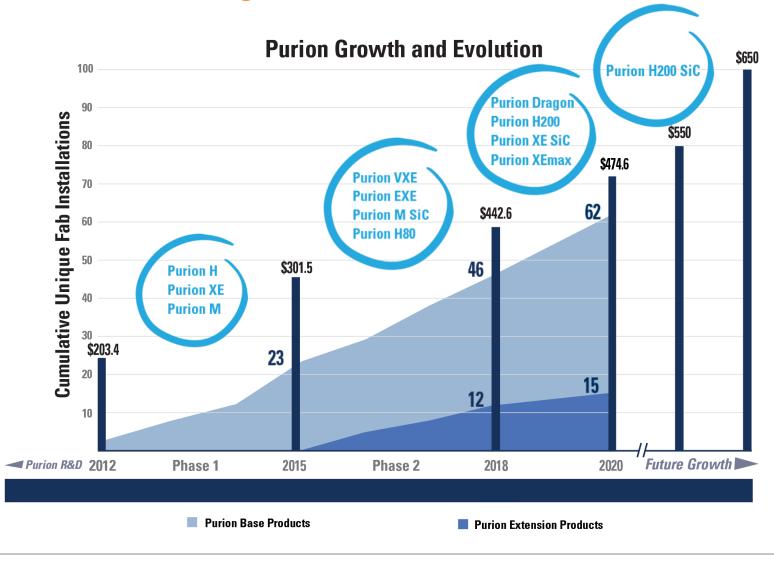
Purion – The Core of Our Growth Strategy Expanding Into New High Value Applications



- Innovative scanned spot beam architectures with advanced energy filters
- Common endstation and control system
- Advanced source technology

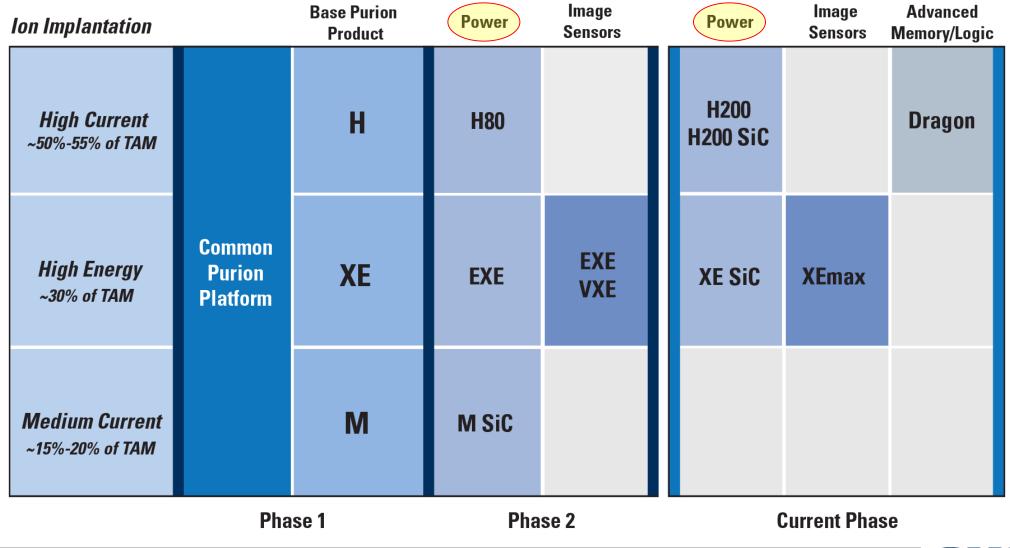


Purion – Fueling Axcelis' Growth



- Introduced new Purion products that solve high value, high impact implant challenges that will drive customer, employee and investor satisfaction
- Created the organization required to develop the common platform and base products
- Established differentiated segment-focused Purion products that specifically meet customers' emerging implant challenges
- Accelerated the segment-focused strategy into the high current market that represents ~50%-55% of the lon Implant TAM
 Axcelis

New Purion Products Target High Value Applications and Market Segments





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Purion Power Series – Enabling Advanced Power Device Technology

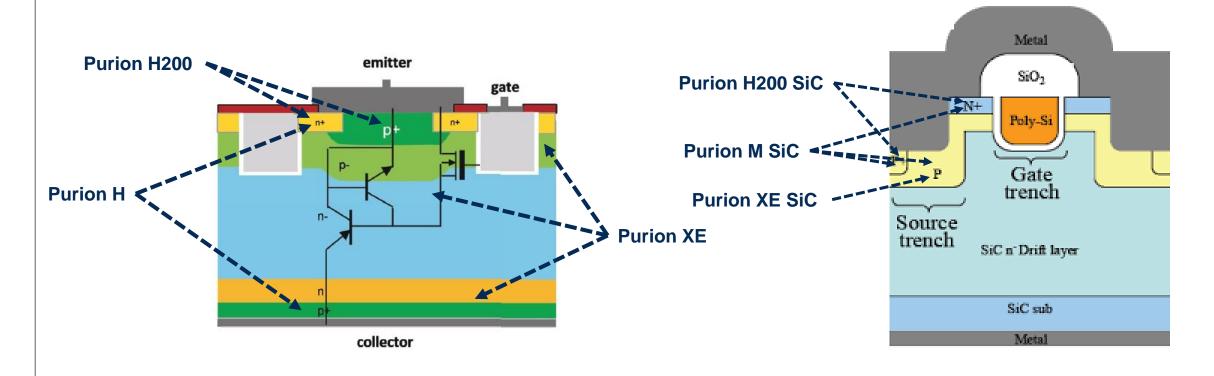
Purion			SiC			Si		
Power Series		Μ	XE	H 200	Μ	XE	Η	H200
	Aluminum Implantation	~	\checkmark	~				
	150mm Wafer Handling	\checkmark	\checkmark	\checkmark				
	Hot Implantation to 700°C For 150mm Wafers	\checkmark	\checkmark	\checkmark				
	80keV Antimony Implantation						\checkmark	
	200mm Thin Wafer Handling				\checkmark	\checkmark	~	
	80keV High Current Capability						✓	
	200keV High Current Capability			\checkmark				\checkmark



Power Devices are Extremely Ion Implant Intensive

Si IGBT Power Device

SiC Trench MOSFET Power Device





Recent Purion Placements Supporting the Power Device Market

AXCELIS ANNOUNCES FIRST ORDER FOR PURION IN JAPAN

System Provides Enabling Technology to Meet the Unique Needs of Emerging Power Device Applications

BEVERLY, Mass., April 2, 2020 -- Axcelis Technologies, Inc. (Nasdaq: ACLS), a leading supplier of innovative, high-productivity solutions for the semiconductor industry, announced today that it has received an order to ship its first Purion system into Japan. The order, from a leading Japanese semiconductor manufacturer, is for the Purion XE Power Series[™] implanter. This Purion XE product line extension will be used in high volume production of power devices supporting automotive, mobile and IoT applications.

AXCELIS SHIPS PURION H200[™] HIGH CURRENT IMPLANTER TO A SECOND LEADING POWER DEVICE MANUFACTURER

Innovative System Features Enabling Technology for Power Device Applications

BEVERLY, Mass., Feb. 2, 2021 -- Axcelis Technologies, Inc. (Nasdaq: ACLS), a leading supplier of innovative, high-productivity solutions for the semiconductor industry, announced today the second shipment of the Purion H200TM high current implanter. The Purion H200 system went to a leading power device manufacturer, targeted for use in a production ramp for Si power devices. The system shipped in the fourth quarter.

AXCELIS SHIPS FIRST PURION H200[™] HIGH CURRENT IMPLANTER AND FOLLOW ON PURION M SIC[™] MEDIUM CURRENT IMPLANTER TO LEADING POWER DEVICE MANUFACTURERS

Purion Systems Feature Enabling Technology for Power Device Applications

BEVERLY, Mass., Sept. 30, 2020 -- Axcelis Technologies, Inc. (Nasdaq: ACLS), a leading supplier of innovative, high-productivity solutions for the semiconductor industry, announced today the first shipment of a Purion H200 high current implanter evaluation system, as well as another follow on order for a Purion M SiC medium current implanter to leading power device manufacturers. The Purion H200 system is targeted for use in a production ramp for Si power devices and the Purion M SiC system is being utilized for a fab capacity expansion. Both systems shipped in the third quarter.

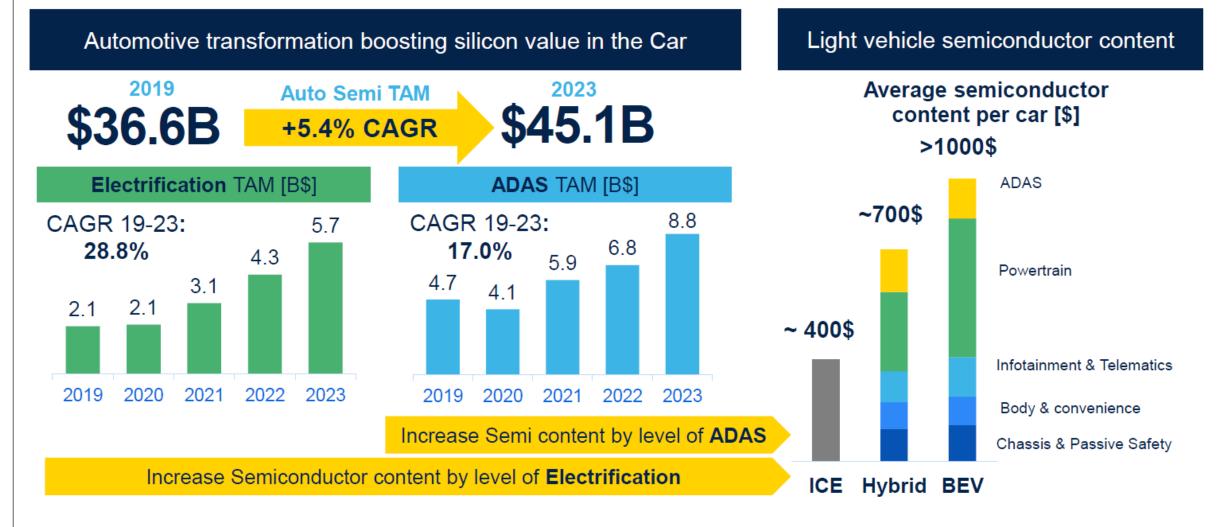
AXCELIS ANNOUNCES FIRST SHIPMENT OF 'PURION H200 SIC POWER SERIES' IMPLANTER

Enabling Technology for SiC Power Device Applications

BEVERLY, Mass., March 8, 2021 -- Axcelis Technologies, Inc. (Nasdaq: ACLS), a leading supplier of innovative, high-productivity solutions for the semiconductor industry, announced today that it has shipped the first Purion H200 SiC Power Series[™] implanter. The new Purion H200 product line extension, featuring innovative silicon carbide capability, shipped to a leading power device manufacturer to support a production ramp for SiC power devices. The system shipped in the first quarter.



Automotive Megatrends Driving Silicon Consumption



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Source: IHS - Automotive semiconductor market tracker

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Strong Systems Revenue Growth in Key Target Market Segments for 2020

- Long term growth expected in key market segments due to the highly differentiated Purion ion implanters and extensions
- Automotive adoption of EV and ADAS expected to drive high growth in power and image sensor devices
- 5G adoption expected to drive growth across all semiconductor market segments

Mature Process Technology - 71%		Memory - 29%			
	Image Sensor, 19%	DRAM, 15%			
General Mature Devices, 35%	Power Device, 17%	NAND, 13%	*		

2020 Market Segment Systems Revenue



Target Business Model (GAAP) The Path to Market Share Leadership

Revenue	\$301.5M 2015(A)	\$267.0M 2016(A)	\$410.6M 2017(A)	\$442.6M 2018(A)	\$343.0M 2019(A)	\$474.6M 2020(A)	\$550M Model*	\$650M Model*
Gross Margin	33.7%	37.3%	36.6%	40.6%	42.0%	41.8%	42-43%	44-45%
Total OPEX	26.8%	31.1%	24.9%	27.0%	35.0%	29.6%	~25%	~24%
Operating Profit	6.9%	6.2%	11.7%	13.5%	7.1%	12.2%	17-18%	20-21%
Free Cash Flow (Cash From Operations – Capex)	5.5%	(4.1%)	11.9%	9.5%	(7.5%)	13.2%	>15%	>17%**

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* The model is not a forecast of results but is intended to be indicative of the annual results Axcelis may achieve based on our strategic objectives
** Assumes our federal net operating loss carryforwards have been consumed and Axcelis is now paying cash taxes

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